



Ion Beam Analysis and Modification for Current Issues in Surface Science

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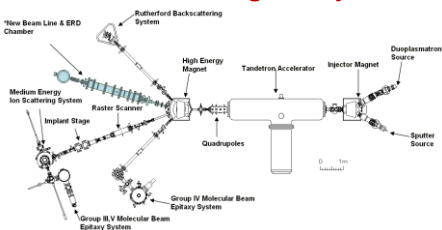
Outline

- Production of Ion Beams
- Basics of Ion-Solid Interactions
- I: Ion Beam Analyses**
 - Rutherford Backscattering Spectrometry
 - Elastic Recoil Detection
 - Medium Energy Ion Scattering
 - Research Examples: interfacial analysis of complex oxide thin film stacks; diffusion and oxidation processes with sub-nm resolution
- II: Ion Beam Modification**
 - Implantation
 - Research Examples: formation of Si and Ge quantum dots
- Conclusions
- References



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Tandem Ion Scattering facility at UWO



Rutherford Backscattering (RBS) and Medium Energy Ion Scattering (MEIS)
Elastic Recoil Detection (ERD)
Nuclear Reaction Analysis (NRA)
Particle-Induced X-ray Emission (PIXE)
Various implantation capabilities...



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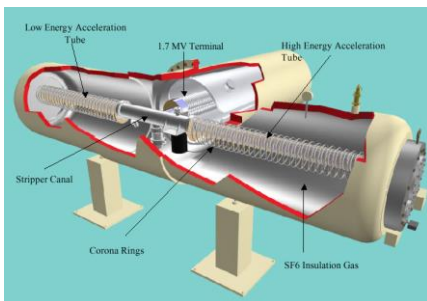
Tandetron operating principle

- (1) Begin with **negative ions** via sputtering for most species
- (2) Accelerate to kinetic energy = qV_t , where V_t = terminal voltage (MV) and $q_i = -1$ so that $E_i \equiv V_t$ [MeV]
- (3) Ions traverse a **stripper gas** at the high voltage terminal to produce a charge state distribution of **positive ions**
- (4) Accel/decel mode is available when the stripper gas is **OFF**: used for $E_{ion} \leq 100$ keV and the incident ions then have $q_i = -1$



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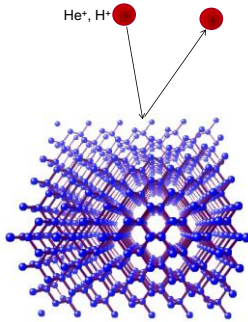
Inside Tandetron...





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Ion Beam Analysis



- (1) elastic scattering
⇒ Rutherford Backscattering
- (2) fast recoils arising from elastic scattering
⇒ Elastic Recoil Detection
- (3) steering effects due to the crystalline structure of target atoms (channeling)
- (4) inelastic processes: energy loss as a function of depth
- (5) X-ray emission (PIXE) and nuclear reactions (NRA)

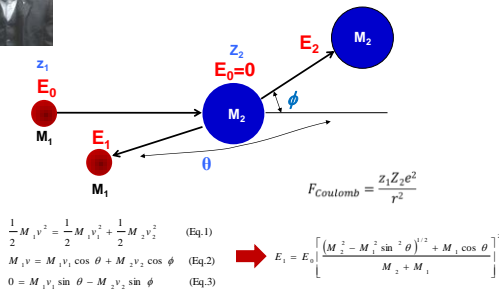


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Rutherford Backscattering Spectrometry Elastic Collisions!



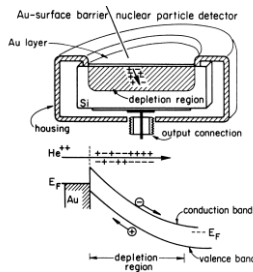
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Charged Particle Detectors

Schematic diagram of the operation of a surface barrier detector (SBD)

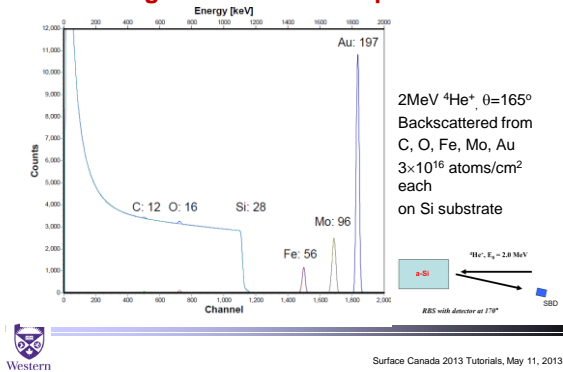
- Silicon disc with gold film mounted in the detector housing
- He++ particle is forming holes and electrons over its penetration path.
- The energy band diagram of a reverse biased detector (positive polarity on n-type silicon) shows the electrons and holes swept apart by the high electric field within the depletion region.



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Scattering kinematics: example 1



Key features of RBS

Ability to quantify depth profile of buried species with a precision of $\sim 3\%$

Qualitative information: **kinematic factor, k**

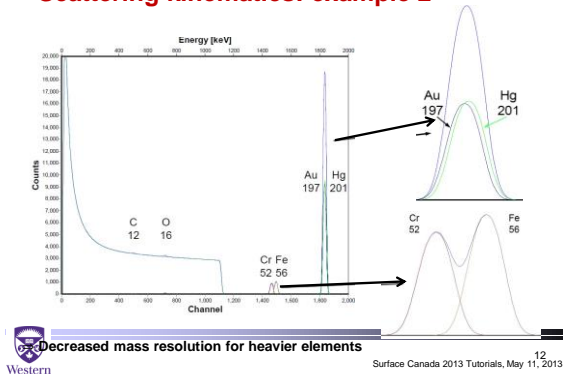
$$k = \frac{E_1}{E_2} = \left[\frac{(M_2 - M_1 \sin^2 \theta)^{1/2} + M_1 \cos \theta}{M_2 + M_1} \right]^2$$

Quantitative: **scattering cross section, σ**

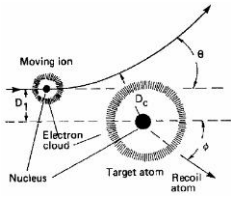
$$\frac{d\sigma}{d\Omega} = \sigma(\theta) = \left(\frac{Z_1 Z_2 e^2}{4 E \sin^2 \left(\frac{\theta}{2} \right)} \right)^2$$



Scattering kinematics: example 2



Rutherford Cross Section



- Neglecting shielding by electron clouds
 - Distance of closest approach large enough that nuclear force is negligible
- ⇒ Rutherford scattering cross section

$$\frac{d\sigma}{d\Omega} = \sigma(\theta) = \left(\frac{Z_1 Z_2 e^2}{4 E \sin^2 \left(\frac{\theta}{2} \right)} \right)^2$$

Note that sensitivity increases with:

- Increasing Z_1
- Increasing Z_2
- Decreasing E



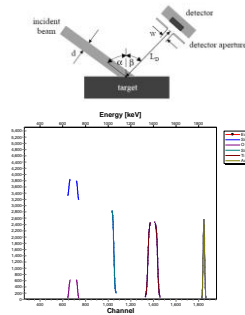
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RBS spectra from thin and thick films

The integrated peak count A_i for each element on the surface can be calculated using this equation:

$$A_i = (Nt)_i \times Q \times \Omega \times \frac{\sigma(E, \theta)}{\cos \theta}$$

where
 $(Nt)_i$ is areal density, atoms per unit area;
 Q – ion beam fluency;
 Ω – solid angle of the detector;
 $\sigma(E, \theta)/\cos \theta$ – cross section of an element



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Ion dose (fluency), solid angle, cross section

- **Ion dose (fluency), the number of incident particles (collected charge)**
 - measured by Faraday cup
 - $Q = I \times t$
- **Solid angle, in steradians, sr**
 - stays constant for a particular detector/detector slit
 - need to be verified by the calibration standard measurements
- **Cross section (or differential cross section), in cm^2/sr of the element**
 - well known (tabulated) in Rutherford cross section regime



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Areal density: note about units

Areal density = ρt [g/cm²],

where $\rho = \text{g/cm}^3$, $t = \text{cm}$

$$\rightarrow \frac{N_0 \rho t}{M} \quad [\text{at./cm}^2]$$

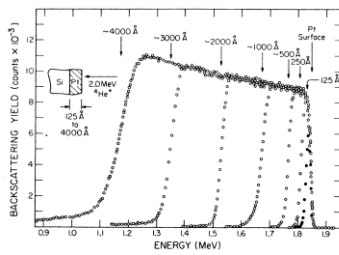
where $M = \text{atomic mass [amu]}$, $N_0 = \text{Avogadro's number}$

In absolute numbers – close to thickness in Å



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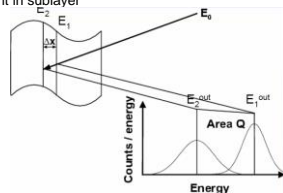
Thickness measurement



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RBS Spectrum of a thick film

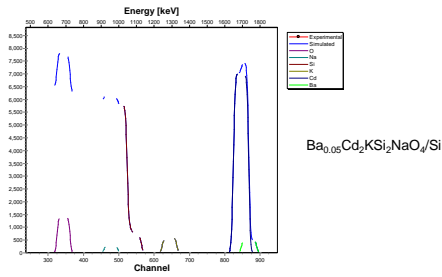
- Target is divided into thin sublayers ("slabs")
- Calculate backscattering from front and back side of each sublayer taking energy loss into account
- For each isotope of each element in sublayer



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Stoichiometry

2MeV $^4\text{He}^+$, backscattered from ceramic films on Si substrate

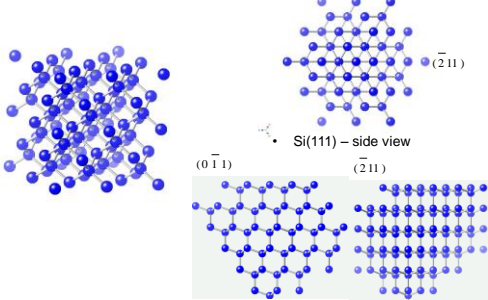


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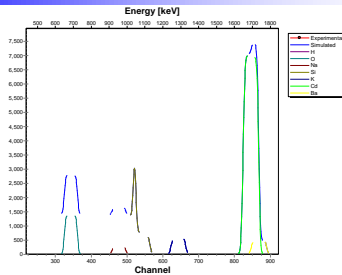
Ion channeling and blocking

Si (diamond structure)

- Si(111) $(0\bar{1}1)$ (211)
- Si(111) – side view $(0\bar{1}1)$ (211)



Use crystal structure of the substrate

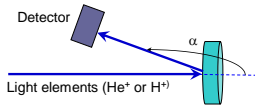


- Substrate can be aligned to a major crystallographic direction to minimize background signal in some cases

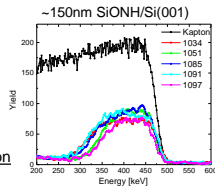
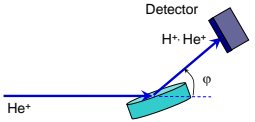
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Elastic Recoil Detection (ERD)

Heavy Elements by MEIS or RBS



Light Elements by Elastic Recoil Detection



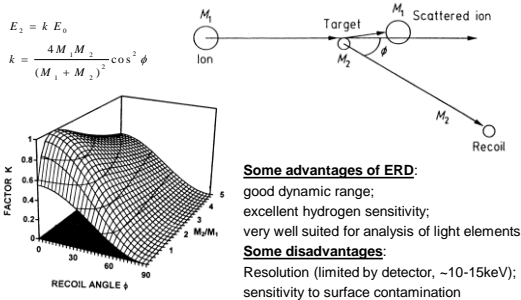
"Classical" ERD
Incident energy = 1.6MeV He⁺
Incident angle = 75°
Recoil Angle = 30°
Al-mylar (range foil)



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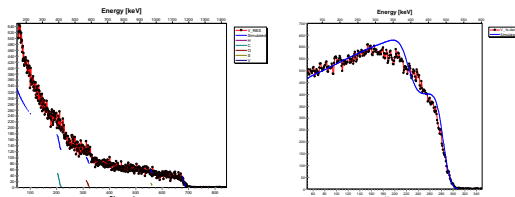
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ERD Principles and Limitations



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RBS plus ERD ⇒ Full Stoichiometry!!!



RBS and ERD results for $\text{VS}_x\text{O}_y\text{C}_z\text{:H}$

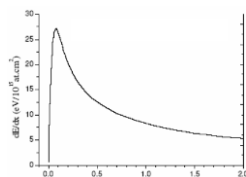
Assumption: ~ 900Å $\text{V}_{0.03}\text{S}_{0.03}\text{O}_{0.25}\text{C}_{0.44}\text{H}_{0.29}$ (bulk) $\text{V}_{0.03}\text{S}_{0.03}\text{O}_{0.13}\text{C}_{0.44}\text{H}_{0.37}$



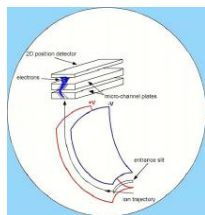
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A comparison between RBS and MEIS



Close to maximum of $\sim 14 \text{ eV/\AA}$ at $\sim 100 \text{ keV}$!
This helps, but the greater advantage is the use of better ion detection equipment!



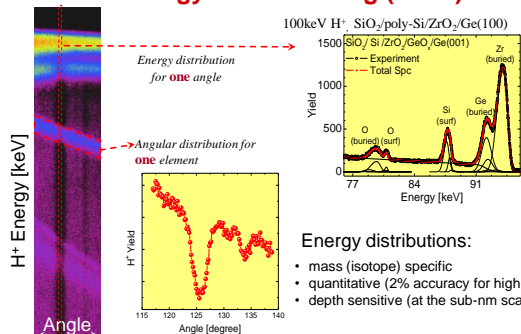
	RBS	MEIS
Ion energy	$\sim 2 \text{ MeV}$	$\sim 100 \text{ keV}$
Detector resolution	$\sim 15 \text{ keV}$	$\sim 0.15 \text{ keV}$
Depth resolution	$\sim 100 \text{ \AA}$	$\sim 3 \text{ \AA}$

2 basic advantages vs. RBS: Often better dE/dx , superior detection equipment



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Medium Energy Ion Scattering (MEIS)



Energy distributions:

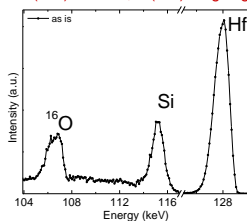
- mass (isotope) specific
- quantitative (2% accuracy for high-Z)
- depth sensitive (at the sub-nm scale)



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MEIS analysis of as-deposited films

98keV H^+
Sample Alignment:
 $\text{Si}(001)$ incident; $\text{Si}(110)$ outgoing



HfO ₂	29Å
SiO ₂	7Å
Si	

TEM:
2.8nm HfO₂/1nm SiO₂/Si(001)



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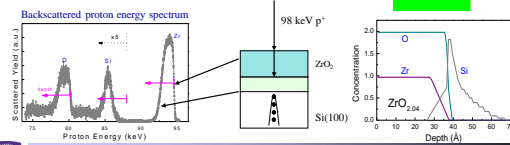
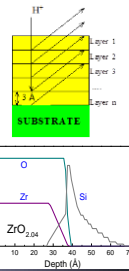
Depth resolution and concentration profiling

Basic concept: Depth profile is based on the energy loss of the ions traveling through the film (stopping power $\varepsilon \propto dE/dx$).

Example: Depth resolution for ≈ 95 keV protons
With MEIS spectrometer ≈ 180 eV vs RBS detector ≈ 15 keV

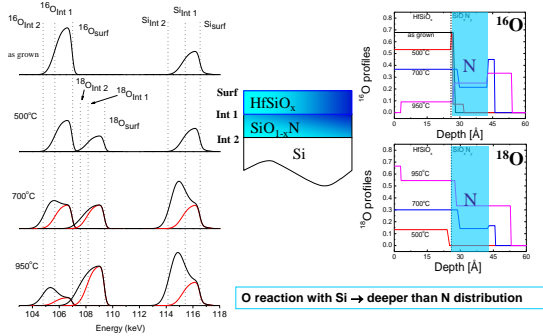
- Stopping power $\text{SiO}_2 \approx 12$ eV/Å; $\text{Si}_3\text{N}_4 \approx 20$ eV/Å;

Layer model:



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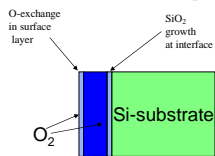
Oxidation temperature dependence: ^{16}O and ^{18}O



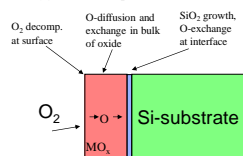
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Oxygen diffusion in oxides

Oxygen (O_2) transport in SiO_2



Atomic oxygen (O) transport in metal oxide films



SiO_2 films:

- amorphous after annealing
- molecular O_2 transport in SiO_2
- decomposition by SiO desorption

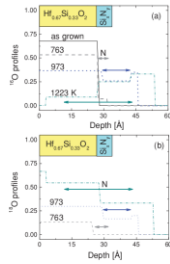
(Many) metal oxide films:

- tend to crystallize at low T
- atomic O transport in the film
- high oxygen mobility



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Diffusion and interface growth in HfO_2 and HfSiO_x ultrathin films on $\text{Si}(001)$



	T (°C)	Time (min)	Oxide growth (Å)
High-k	700	30	11
	800	30	18
	950	30	25
SiO_2	750	165	5
		2640	10
		60	10
	900	1860	27

- Faster interfacial SiO_2 growth in case of high-k oxides in comparison to the SiO_2 thickness growth for bare Si

L.V. Goncharova, M. Dalponte, T. Feng, et al, *PRB* **83** (2011) 115329

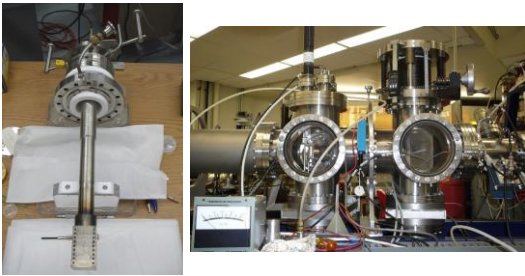


*Gusev, Lu, Gustafsson, Garfunkel, *PRB* **52** (1995) 1759.

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Part II: Ion Implantation



- Implantation chamber and implantation stage



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Periodic Table

WebElements: the periodic table on the world-wide web
www.weblelements.com

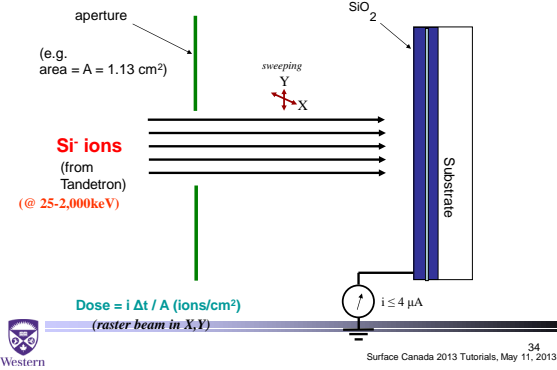
- We can produce beams of all those elements shown in yellow !



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Ion Implantation

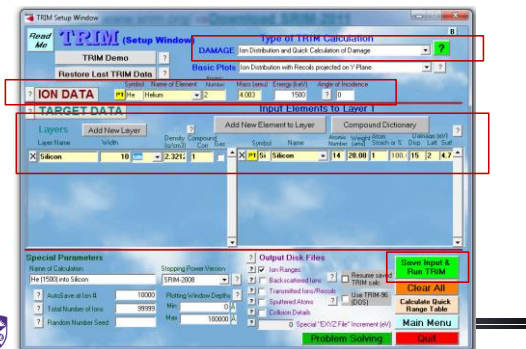


Stopping and Range of Ions in Matter (SRIM)

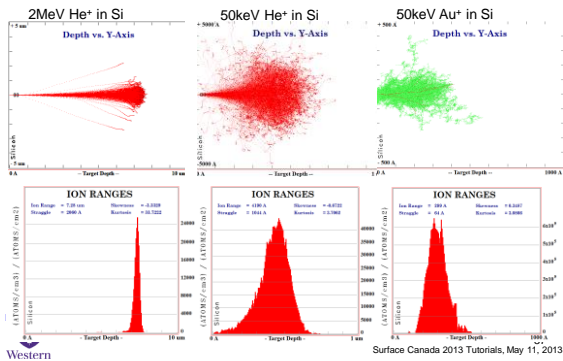
<http://www.srim.org/> → Download SRIM-2008



SRIM Setup Window

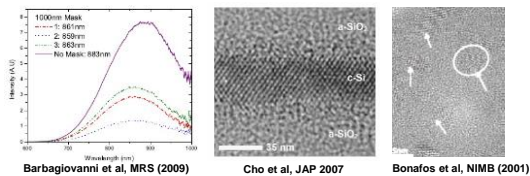


Calculated Ion Trajectories



Ion-implanted Si and Ge quantum dots in dielectrics

- Second generation Si and Ge photonics
- Strong light emission from nanocrystals or quantum dots (QD) by reducing the size of Si to < a_{Bohr} (Si ~3-5nm; Ge ~ 24nm)
- Porous Si and crystalline QW
- Bonafos et al. used TEM to relate Si QD to excess Si (10, 20, 30%)



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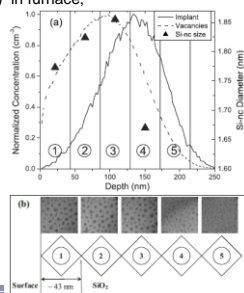
Growth of Si-QD

- RT Implantation Si⁺ (Ge⁺) 90keV 5×10^{16} - 1×10^{17} ions/cm²
- 120min @1100°C (Si) or 900°C (Ge) in furnace,
- 60 min @500°C in N₂/H₂ gas

- Early stage of formation governed by diffusion

$$\frac{\partial C}{\partial t} = -4\pi rND (C_{\text{Si}} - C_{\text{sol}})$$

- Eventually Ostwald ripening

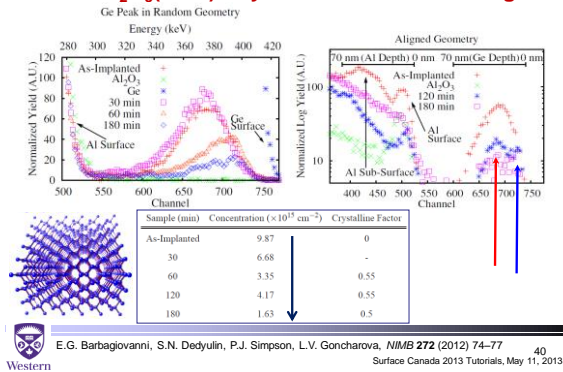


Link between defects in the SiO₂ and formation of Si-QDs

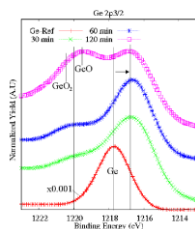


Mokry C.R., Simpson P.J., Knights A.P. J. Appl. Phys. 105 (2009) 154405

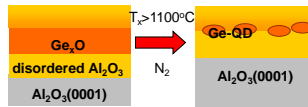
Ge in Al₂O₃(0001): crystallization and ordering



XPS



Sample (min)	Concentration ($\times 10^{15} \text{ cm}^{-2}$)	Crystalline Factor
As-Implanted	9.87	0
30	6.68	-
60	3.35	0.55
120	4.17	0.55
180	1.63	0.5

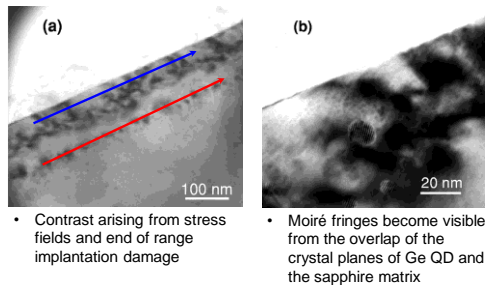


Ar sputtering prior to XPS analysis:
Ge layer is 3–5 nm deep

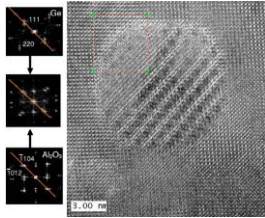
- Shift of Ge peak towards the surface (RBS)
- GeO_x peaks in XPS \Rightarrow Ge loss via GeO desorption



Cross-sectional TEM micrographs



Ge in Al₂O₃(0001): crystallization and ordering



- Slow diffusion rate of the alumina matrix atoms at $< T_{\text{melt}}$
- Ge blocking minimum can be related to the stereographic projection of the sapphire crystal and corresponds to the [111] scattering plane:

(1104) Al₂O₃ // (111)Ge and [211] Al₂O₃ // [112] Ge



I.D. Sharp, Q. Xu, D.O.Yu, et al. JAP **100** (2006) 114317

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Conclusions and future directions:

- Ion Beam Analysis is an enabling technology for thin film scientists and engineers
- Our goals are to initiate collaborative research projects and stimulate multidisciplinary interactions, To enable the use of ion beams, including the introduction of ion beam methods to new discipline areas
- Development of novel ion beam analyses techniques



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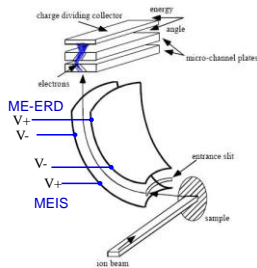
References:

- 1) L.C. Feldman, J.W. Mayer (1986) Fundamentals of Surface and Thin Film Analysis.
- 2) Y. Wang, M. Nastasi (2010, or previous edition) Handbook of Modern Ion Beam Materials Analysis.
- 3) The Stopping and Range of Ions in Matter (SRIM), <http://www.srim.org/>



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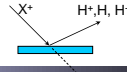
Elastic recoil detection for negative ions



- Crucial points for detecting H ion recoils directly are:
- To **increase** the recoil cross-section
 - To **reduce** (to suppress) the background originating mainly from elastically scattered incident ions

Only charged particles are detected by TEA

⇒ use incident beam ions without negative ion fractions and detect negative H⁻ recoils



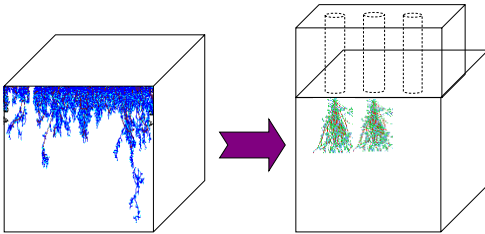
Toroidal Ion Energy Analyzer (HVEng, Amersfoort, The Netherlands)



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Control QD Distribution with Mask

Si QD nucleation and growth by Si ion implantation and anneal ⇒
Lateral separation between implanted regions



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Thank you!

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